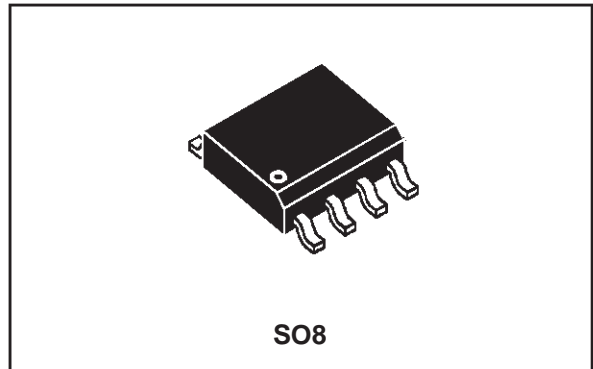


Application Specific Discretes
A.S.D.TM

DIODE ARRAY

APPLICATION

Protection of logic side of ISDN S-interface.
Protection of I/O lines of microcontroller.
Signal conditioning.



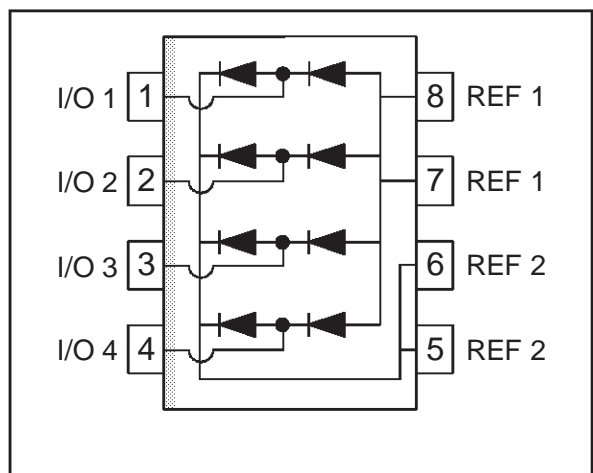
FEATURES

- ARRAY OF 8 OR 12 DIODES
- LOW INPUT CAPACITANCE
- SUITABLE FOR DIGITAL LINE PROTECTION

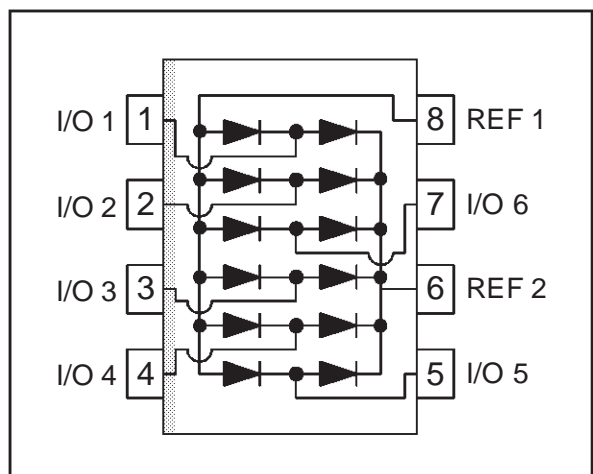
DESCRIPTION

ARRAY of 8 or 12 diodes configured by cells of 2 diodes, each cell being used to protect signal line from transient overvoltages by clamping action.

FUNCTIONAL DIAGRAM : DA108S1



FUNCTIONAL DIAGRAM : DA112S1



COMPLIES WITH FOLLOWING STANDARDS :

IEC1000-4-22 level 4: 15kV (air discharge)
8kV (contact discharge)

DA108S1 / DA112S1

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^{\circ}\text{C}$)

Symbol	Parameter	Value	Unit
V_{RRM}	Repetitive peak reverse voltage (for one single diode)	18	V
I_{PP}	Repetitive peak forward current *	8/20 μs	A
P	Power dissipation	0.73	W
T_{stg} T_j	Storage temperature range Maximum operating junction temperature	- 55 to + 150 150	$^{\circ}\text{C}$
T_L	Maximum lead temperature for soldering during 10s.	260	$^{\circ}\text{C}$

* The surge is repeated after the device returns to ambient temperature

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to ambient	170	$^{\circ}\text{C/W}$

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}\text{C}$)

Symbol	Parameter	Max.	Unit
V_{FP}	Peak forward voltage $I_{PP} = 12\text{A}, 8/20 \mu\text{s}$	9 12	V
V_F	Forward voltage $I_F = 50 \text{mA}$	1.2	V
I_R	Reverse leakage current $V_R = 15\text{V}$	2	μA

Fig.1 : Input capacitance

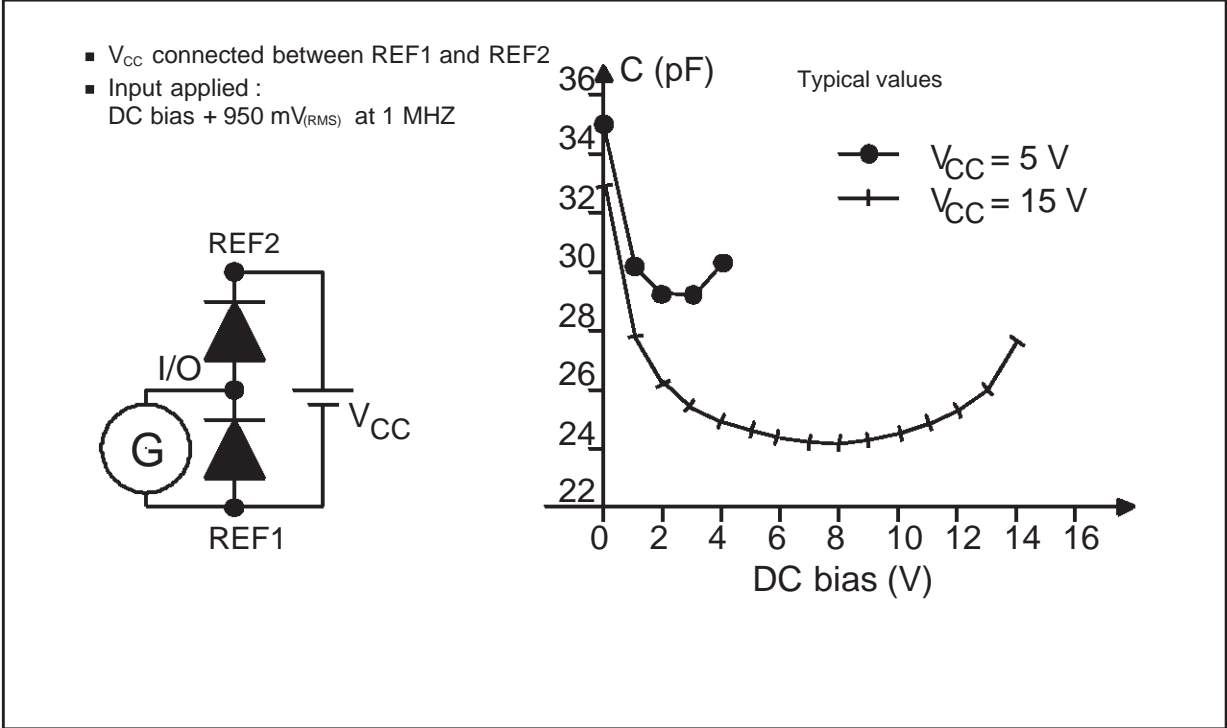
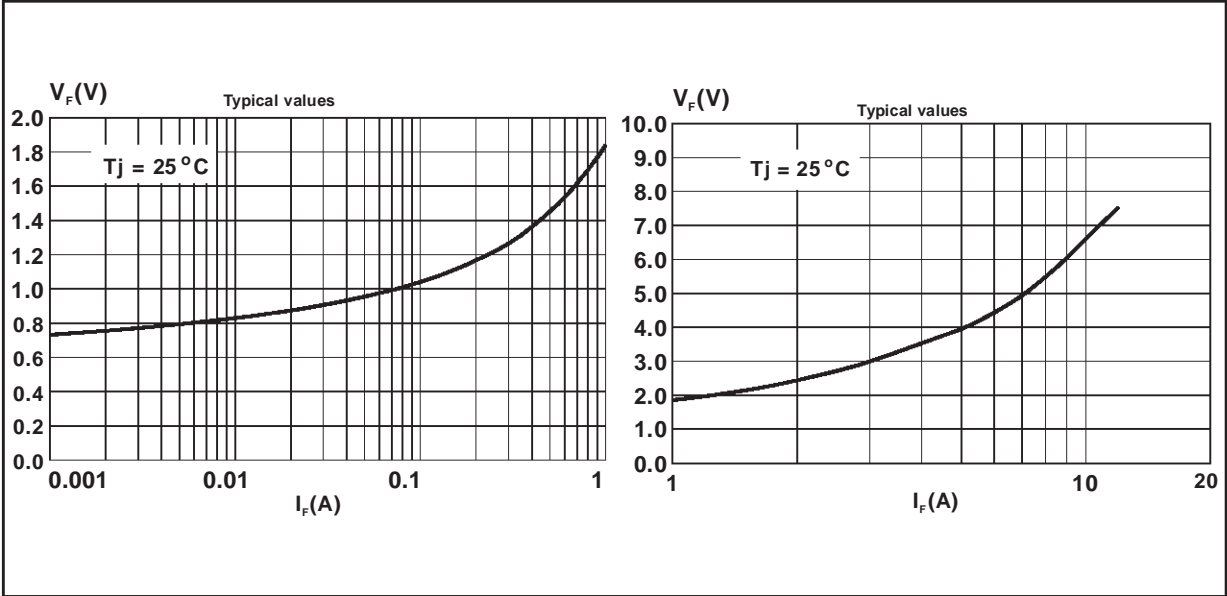


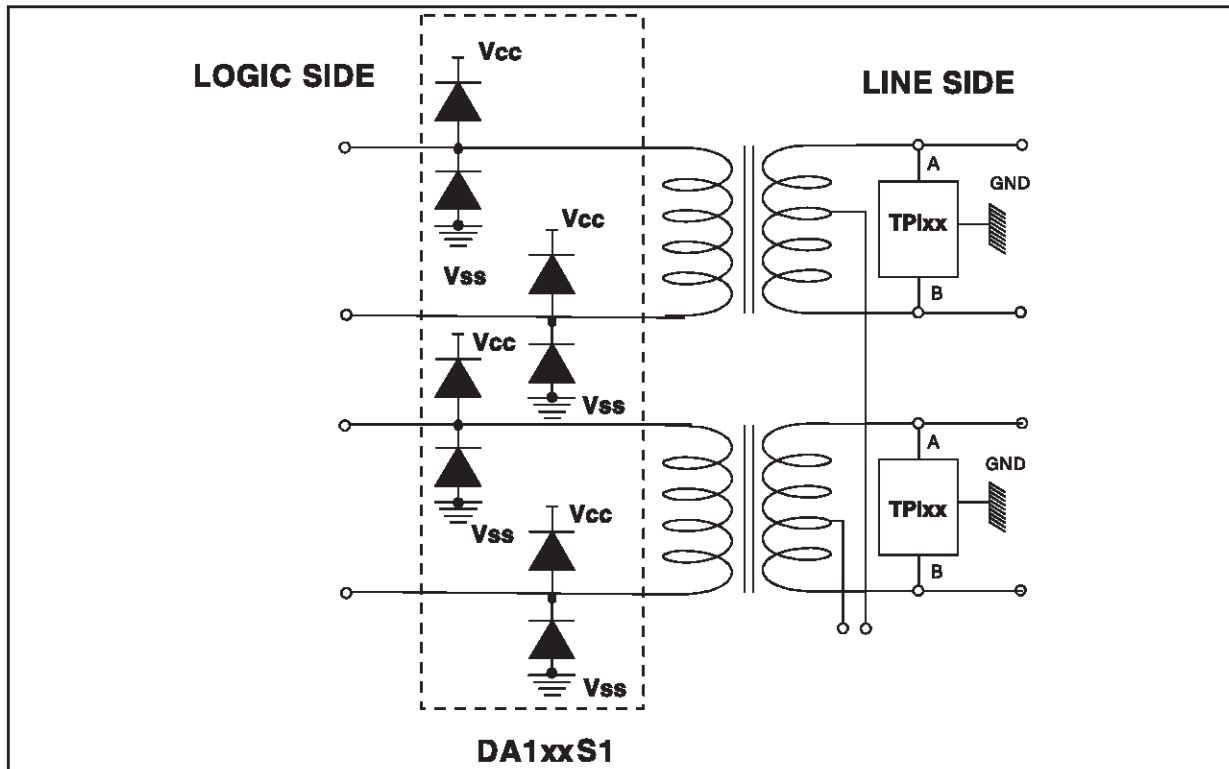
Fig.2 : Typical peak forward voltage characteristics (8/20µs pulse)



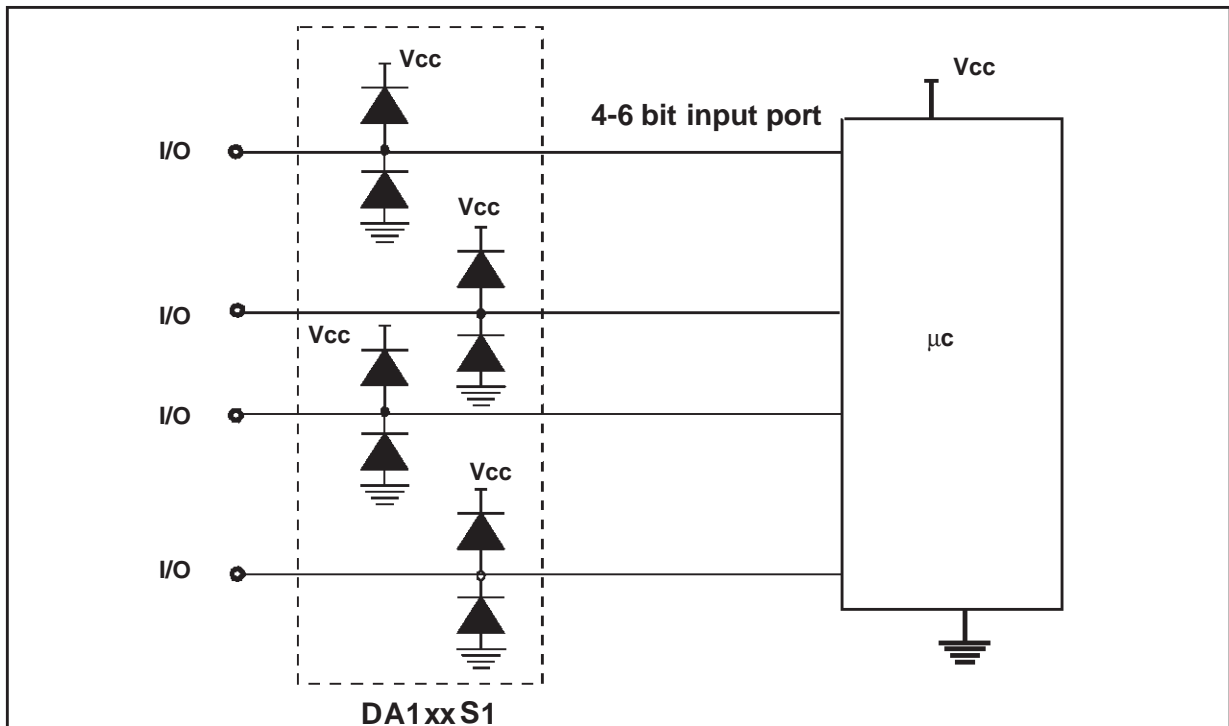
DA108S1 / DA112S1

APPLICATION 1 : ISDN Interface Protection

Residual lightning surges at transformer secondary are suppressed by DA108S1

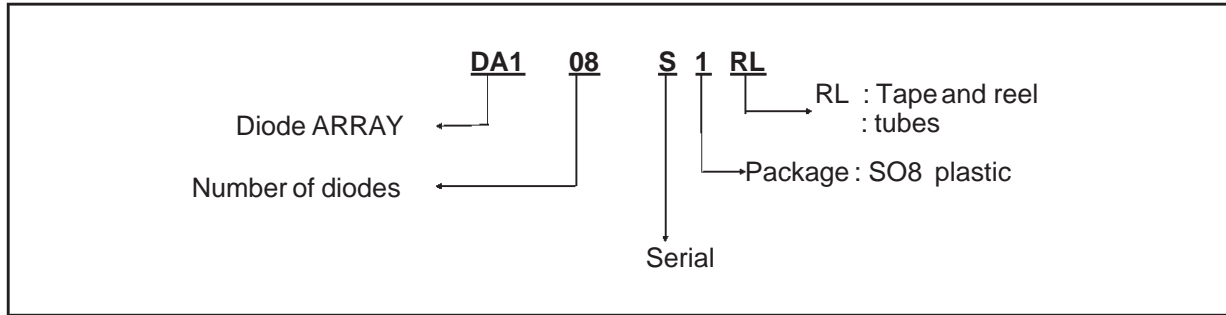


APPLICATION 2 : Microcontroller I/O port protection



IMPORTANT : DA108S1 must imperatively be connected to the reference voltages by REF1 and REF2.

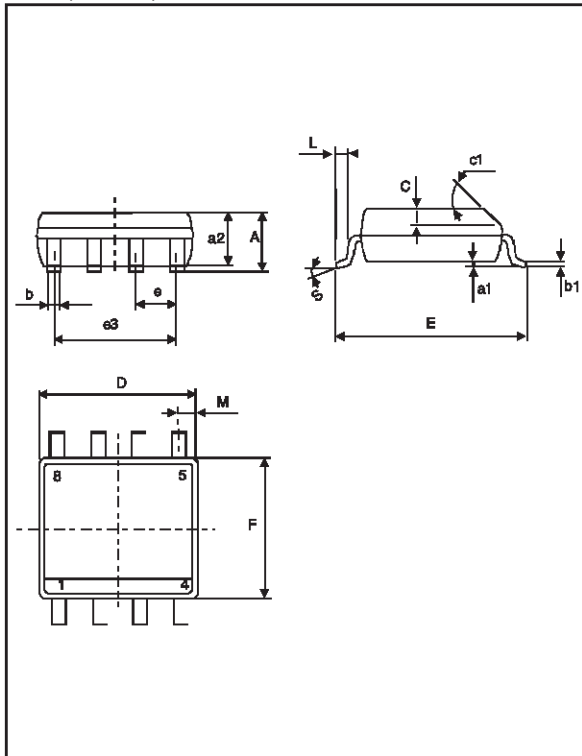
ORDER CODE



MARKING : Logo, Data Code,

DA108S1	DA108S
DA112S1	DA112S

PACKAGE MECHANICAL DATA
SO8 (Plastic)



REF.	DIMENSIONS					
	Millimetres			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
a1	0.1		0.25	0.004		0.010
a2			1.65			0.065
b	0.35		0.48	0.014		0.019
b1	0.19		0.25	0.007		0.010
C		0.50			0.020	
c1	45° (typ)					
D	4.8		5.0	0.189		0.197
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.15		0.157
L	0.4		1.27	0.016		0.050
M			0.6			0.024
S	8° (max)					

Packaging : Preference packaging is tape and reel.

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